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IN THE UNITED STATES PATENT AND TRADEMANK OFFICE

In re application of: Ghoshal et al.

Serial No.: Not Assigned

Filed: February 11, 2002

For: Enhanced Interface

Thermoelectric Coolers with All Metal

Tips

Group Art Unit: 1741

Examiner: Parsons, Thomas H.

Attorney Docket No.: AUS920000414US2

Certificate of Mailing Under 37 C.F.R. § 1.8(a)

I hereby certify this correspondence is being deposited with the United States Postal Service as First Class mail in an envelope addressed to: Assistant Commissioner of Patents, Washington, D.C. 20231 on February

11, 2002.

By:

Krista Douthitt

PRELIMINARY AMENDMENT

Assistant Commissioner of Patents Washington, D.C. 20231

Sir:

No fees are believed to be necessary. If, however, any fees are required, I authorize the Commissioner to charge these fees to Deposit Account No. 09-0447. No extension of time is believed to be necessary. If, however, an extension of time is necessary, I authorize the Commissioner to charge the necessary extension fees to Deposit Account No. 09-0447.

Prior to examination of this application, please amend the above-identified application as follows:

IN THE SPECIFICATION:

On page one, before the BACKGROUND OF THE INVENTION, please insert the following paragraph:

This application is a divisional of application number 09/731,616,

filed December 7, 2000, status allowed.

Please delete the paragraph beginning on page 1, line 9, and replace with the following:

The present application is related to co-pending U.S. Patent Application Serial No.

09/731,997 (IBM Docket No. AUS9-2000-0415-US1) entitled "THERMOELECTRIC

COOLERS WITH ENHANCED STRUCTURED INTERFACES" filed on December 7, 2000, to

co-pending U.S. Patent Application Serial No. 09/731,999 (IBM Docket No. AUS9-2000-0564-

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